UP0487C

Silicon N-channel MOSFET

For switching circuits

■ Features

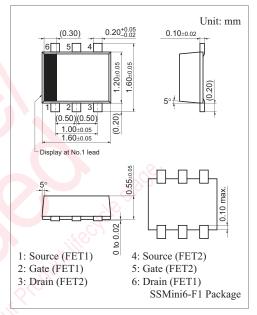
- High-speed switching
- Incorporating a built-in gate protection-diode
- Two elements incorporated into one package (Each transistor is separated)
- SSMini type package, reduction of the mounting area and assembly cost

■ Basic Part Number

• 2SK3937 × 2

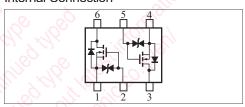
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Drain-source surrender voltage	V_{DSS}	20	V	
Gate-source surrender voltage	V _{GSS}	±12	V	
Drain current	I_{D}	100	mA	
Peak drain current	I_{DP}	200	mA	
Total power dissipation	P_{T}	125	mW	
Channel temperature	T _{ch}	125	°CO	
Storage temperature	T _{stg}	-55 to +125	°C °C	



Marking Symbol: 2V

Internal Connection



■ Electrical Characteristics T_a = 25°C±3°C

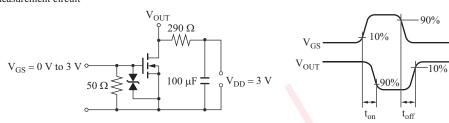
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source surrender voltage	V _{DSS}	$I_D = 10 \mu\text{A}, V_{GS} = 0$	20			V
Drain-source cutoff current	I _{DSS}	$V_{DS} = 10 \text{ V}, V_{GS} = 0$			1.0	μΑ
Gate-source cutoff current	I_{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$			±10	μΑ
Gate threshold voltage	V _{TH}	$I_D = 50 \mu A, V_{DS} = 5.0 V$	0.4		1.3	V
Drain-source ON resistance R _{DS(or}		$I_D = 1 \text{ mA}, V_{GS} = 1.8 \text{ V}$		6	13	Ω
	R _{DS(on)}	$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$		4	6	
		$I_D = 10 \text{ mA}, V_{GS} = 4.0 \text{ V}$		3	4	
Forward transfer admittance	Y _{fs}	$I_D = 10 \text{ mA}, V_{DS} = 3 \text{ V},$	20	55		mS
Short-circuit input capacitance (Common source)	C _{iss}			10		pF
Short-circuit output capacitance (Common source)	C _{oss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		13		pF
Reverse transfer capacitance (Common source)	C _{rss}			5		pF
Turn-on time *	t _{on}	$V_{DD} = 3 \text{ V}, V_{GS} = 0 \text{ V to } 3 \text{ V}, I_D = 10 \text{ mA}$		250		ns
Turn-off time *	$t_{\rm off}$	$V_{DD} = 3 \text{ V}, V_{GS} = 3 \text{ V to } 0 \text{ V}, I_D = 10 \text{ mA}$		480		ns

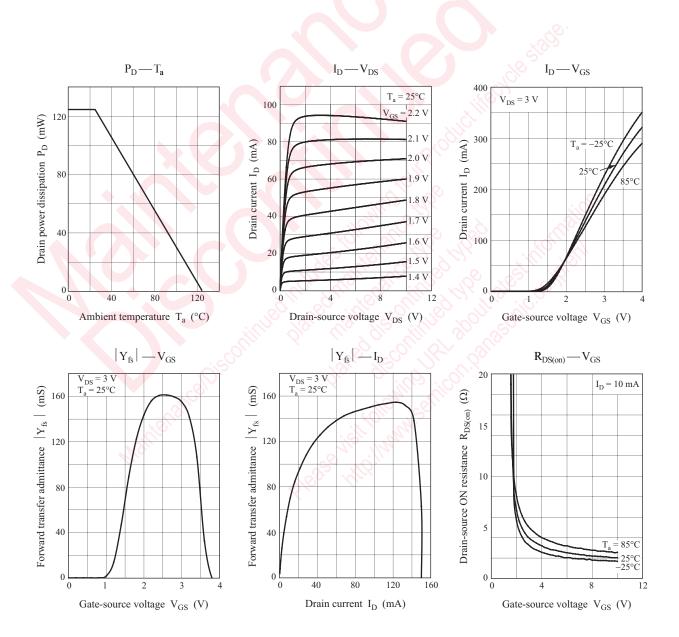
UP0487C Panasonic

■ Electrical Characteristics (continued) $T_a = 25$ °C±3°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. * : t_{on} , t_{off} measurement circuit





2 SJJ00332AED

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